



National Semiconductor

December 1996

# 74LCX240 Low-Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs

## 74LCX240

### Low-Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs

#### General Description

The LCX240 is an inverting octal buffer and line driver designed to be employed as a memory address driver, clock driver and bus oriented transmitter or receiver. The device is designed for low voltage (3.3V) V<sub>CC</sub> applications with capability of interfacing to a 5V signal environment.

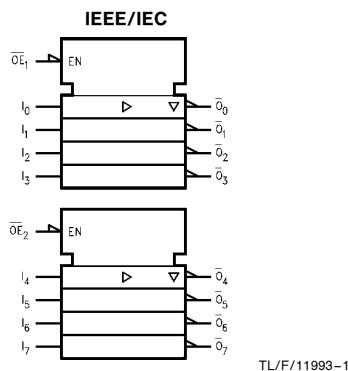
The LCX240 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

#### Features

- 5V tolerant inputs and outputs
- 6.5 ns t<sub>PD</sub> max, 10 µA I<sub>CCQ</sub> max

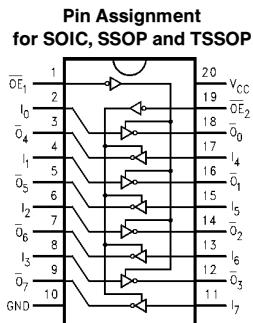
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal
- 2.0V–3.6V V<sub>CC</sub> supply operation
- ±24 mA output drive
- Implements patented Quiet Series™ noise/EMI reduction circuitry
- Functionally compatible with the 74 series 240
- Latch-up performance exceeds 500 mA
- ESD performance:  
Human Body Model > 2000V  
Machine Model > 200V

#### Logic Symbol



TL/F/11993-1

#### Connection Diagram



TL/F/11993-2

Pin Names	Description
OE <sub>1</sub> , OE <sub>2</sub>	TRI-STATE® Output Enable Inputs
I <sub>0</sub> –I <sub>7</sub>	Inputs
O <sub>0</sub> –O <sub>7</sub>	Outputs

#### Truth Tables

Inputs		Outputs (Pins 12, 14, 16, 18)	
OE <sub>1</sub>	I <sub>n</sub>		
L	L	H	
L	H	L	
H	X	Z	

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = High Impedance

Inputs		Outputs (Pins 3, 5, 7, 9)	
OE <sub>2</sub>	I <sub>n</sub>		
L	L	H	
L	H	L	
H	X	Z	

	SOIC JEDEC	SOIC EIAJ	SSOP Type II	TSSOP
Order Number	74LCX240WM 74LCX240WMX	74LCX240SJ 74LCX240SJX	74LCX240MSA 74LCX240MSAX	74LCX240MTC 74LCX240MTCX
See NS Package Number	M20B	M20D	MSA20	MTC20

TRI-STATE® is a registered trademark of National Semiconductor Corporation.  
Quiet Series™ is a trademark of National Semiconductor Corporation.

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Symbol	Parameter	Value	Conditions	Units
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0		V
V <sub>I</sub>	DC Input Voltage	-0.5 to +7.0		V
V <sub>O</sub>	DC Output Voltage	-0.5 to +7.0	Output in TRI-STATE	V
		-0.5 to V <sub>CC</sub> + 0.5	Output in High or Low State (Note 2)	V
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
I <sub>OK</sub>	DC Output Diode Current	-50 +50	V <sub>O</sub> < GND V <sub>O</sub> > V <sub>CC</sub>	mA
I <sub>O</sub>	DC Output Source/Sink Current	±50		mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100		mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

Note 1: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: I<sub>O</sub> Absolute Maximum Rating must be observed.

## Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
V <sub>CC</sub>	Supply Voltage	2.0 Operating Data Retention	3.6 3.6	V
V <sub>I</sub>	Input Voltage	0	5.5	V
V <sub>O</sub>	Output Voltage	HIGH or LOW State TRI-STATE	0 0	V <sub>CC</sub> 5.5
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	V <sub>CC</sub> = 3.0V–3.6V V <sub>CC</sub> = 2.7V	±24 ±12	mA
T <sub>A</sub>	Free-Air Operating Temperature	-40	85	°C
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V	0	10	ns/V

## DC Electrical Characteristics

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C		Units
				Min	Max	
V <sub>IH</sub>	HIGH Level Input Voltage		2.7–3.6	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage		2.7–3.6		0.8	V
V <sub>OH</sub>	HIGH Level Output Voltage	I <sub>OH</sub> = -100 μA	2.7–3.6	V <sub>CC</sub> – 0.2		V
		I <sub>OH</sub> = -12 mA	2.7	2.2		V
		I <sub>OH</sub> = -18 mA	3.0	2.4		V
		I <sub>OH</sub> = -24 mA	3.0	2.2		V
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	2.7–3.6		0.2	V
		I <sub>OL</sub> = 12 mA	2.7		0.4	V
		I <sub>OL</sub> = 16 mA	3.0		0.4	V
		I <sub>OL</sub> = 24 mA	3.0		0.55	V
I <sub>I</sub>	Input Leakage Current	0 ≤ V <sub>I</sub> ≤ 5.5V	2.7–3.6		±5.0	μA
I <sub>OZ</sub>	TRI-STATE Output Leakage	0 ≤ V <sub>O</sub> ≤ 5.5V V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	2.7–3.6		±5.0	μA
I <sub>OFF</sub>	Power-Off Leakage Current	V <sub>I</sub> or V <sub>O</sub> = 5.5V	0		10	μA
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	2.7–3.6		10	μA
		3.6V ≤ V <sub>I</sub> , V <sub>O</sub> ≤ 5.5V	2.7–3.6		±10	μA
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> – 0.6V	2.7–3.6		500	μA

## AC Electrical Characteristics

Symbol	Parameter	$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$				Units	
		$V_{CC} = 3.3\text{V} \pm 0.3\text{V}$		$V_{CC} = 2.7\text{V}$			
		Min	Max	Min	Max		
$t_{PHL}$	Propagation Delay Data to Output	1.5	6.5	1.5	7.5	ns	
$t_{PLH}$		1.5	6.5	1.5	7.5		
$t_{PZL}$	Output Enable Time	1.5	8.0	1.5	9.0	ns	
$t_{PZH}$		1.5	8.0	1.5	9.0		
$t_{PLZ}$	Output Disable Time	1.5	7.0	1.5	8.0	ns	
$t_{PHZ}$		1.5	7.0	1.5	8.0		
$t_{OSHL}$	Output to Output Skew (Note 1)		1.0			ns	
$t_{OSLH}$			1.0				

Note 1: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH to LOW ( $t_{OSHL}$ ) or LOW to HIGH ( $t_{OSLH}$ ).

## Dynamic Switching Characteristics

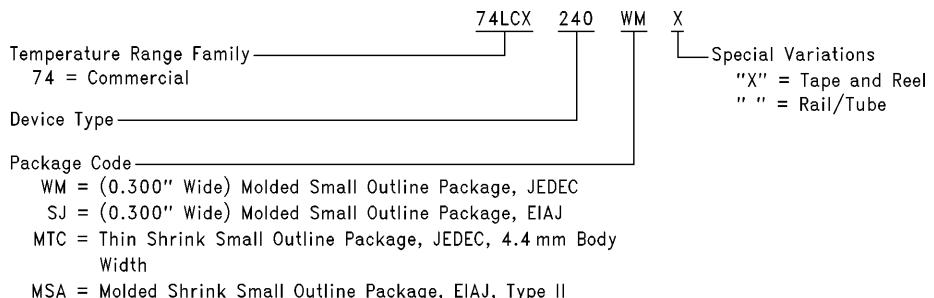
Symbol	Parameter	Conditions	$V_{CC}$ (V)	$T_A = 25^\circ\text{C}$	Units
				Typical	
$V_{OLP}$	Quiet Output Dynamic Peak $V_{OL}$	$C_L = 50 \text{ pF}, V_{IH} = 3.3\text{V}, V_{IL} = 0\text{V}$	3.3	0.8	V
$V_{OLV}$	Quiet Output Dynamic Valley $V_{OL}$	$C_L = 50 \text{ pF}, V_{IH} = 3.3\text{V}, V_{IL} = 0\text{V}$	3.3	-0.8	V

## Capacitance

Symbol	Parameter	Conditions	Typical	Units
$C_{IN}$	Input Capacitance	$V_{CC} = \text{Open}, V_I = 0\text{V}$ or $V_{CC}$	7	pF
$C_{OUT}$	Output Capacitance	$V_{CC} = 3.3\text{V}, V_I = 0\text{V}$ or $V_{CC}$	8	pF
$C_{PD}$	Power Dissipation Capacitance	$V_{CC} = 3.3\text{V}, V_I = 0\text{V}$ or $V_{CC}$ , F = 10 MHz	25	pF

## 74LCX240 Ordering Information

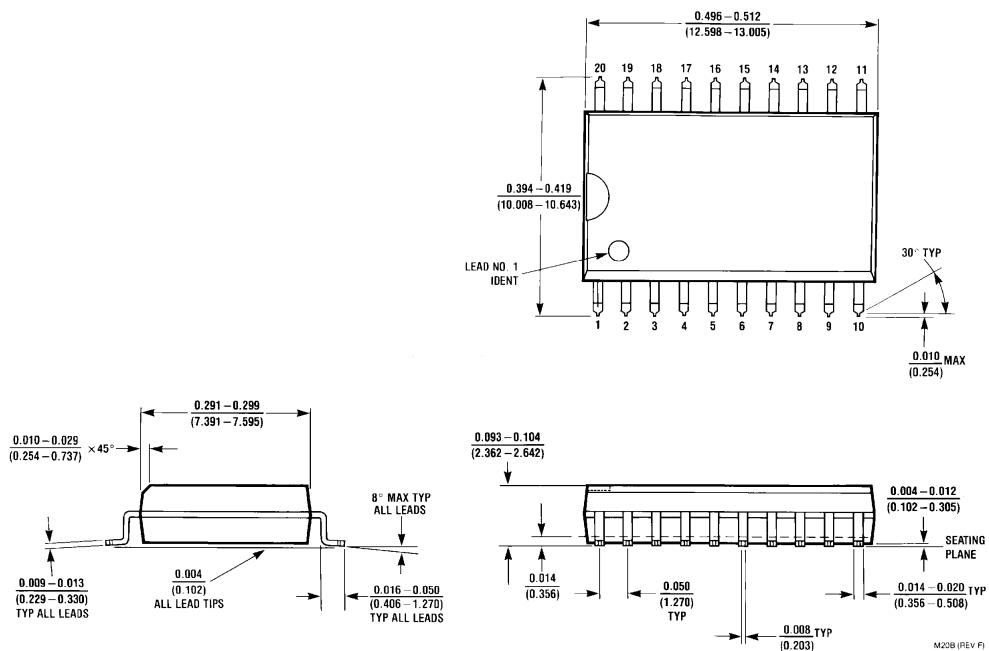
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



TL/F/11993-3

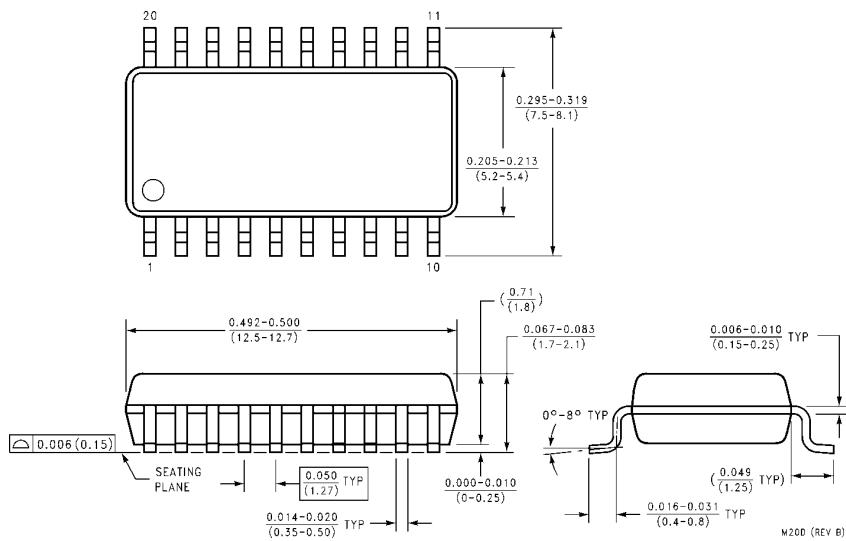
## Physical Dimensions

inches (millimeters) unless otherwise noted

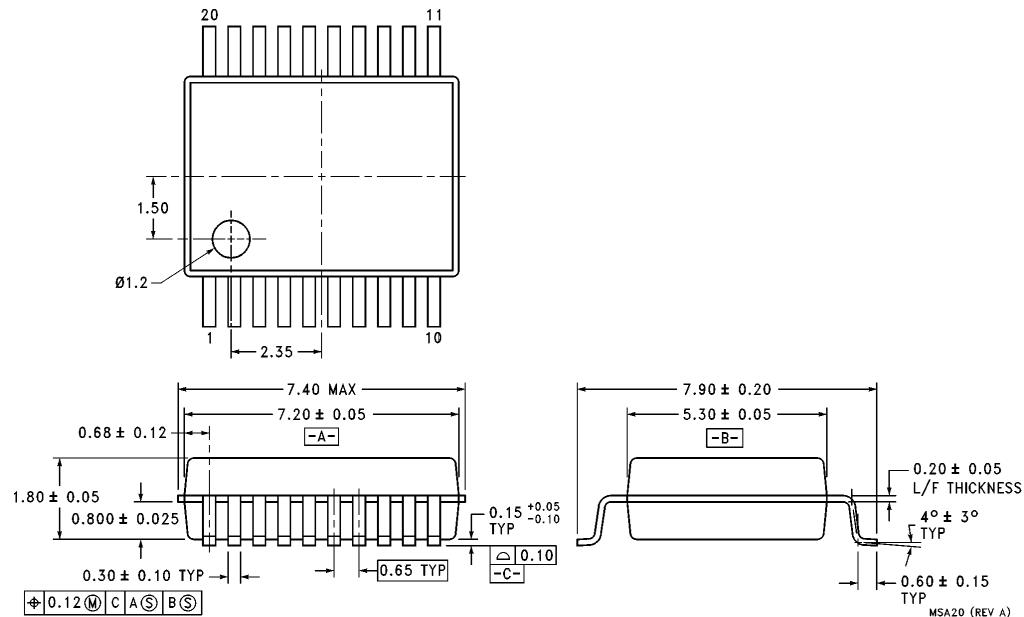


20-Lead Small Outline Integrated Circuit  
Order Number 74LCX240WM or 74LCX240WMX  
NS Package Number M20B

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**20-Lead Small Outline Package, EIAJ (SJ)  
Order Number 74LCX240SJ or 74LCX240SJX  
NS Package Number M20D**



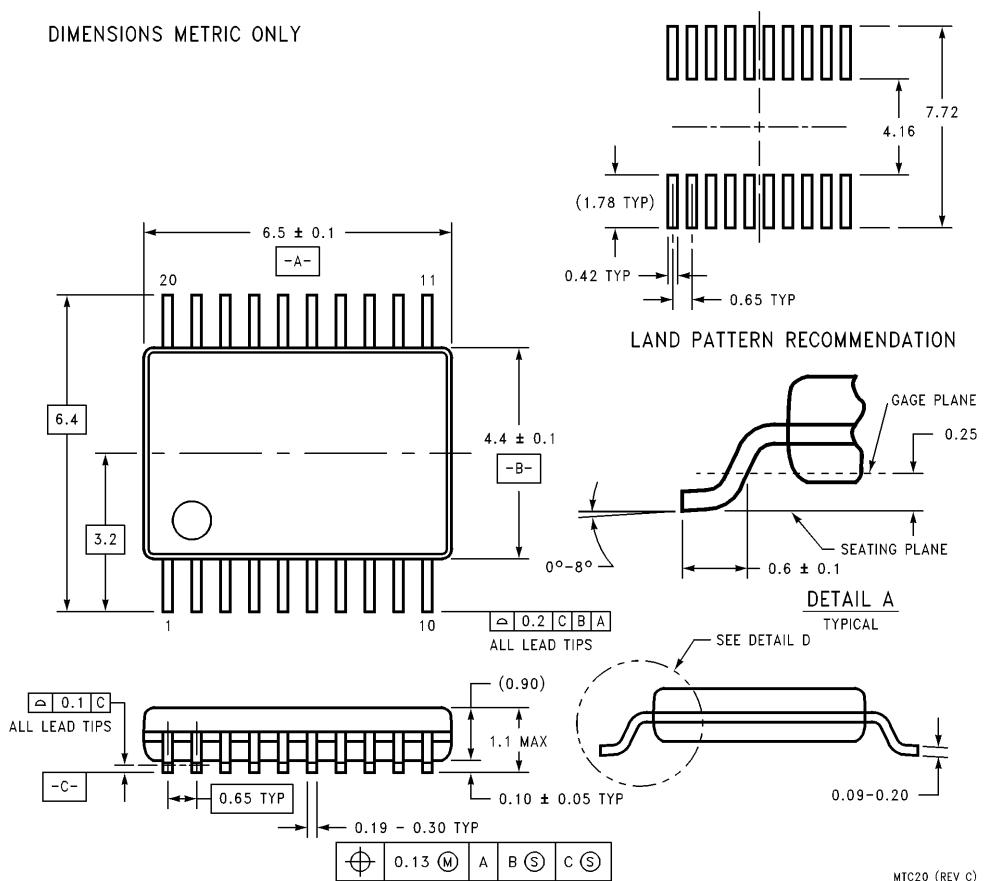
All dimensions are in millimeters.

**20-Lead Molded Shrink Small Outline Package, EIAJ, Type II  
Order Number 74LCX240MSA or 74LCX240MSAX  
NS Package Number MSA20**

# 74LCX240 Low-Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs

## Physical Dimensions All dimensions are in millimeters (Continued)

DIMENSIONS METRIC ONLY



20-Lead Thin Shrink Small Outline Package, JEDEC  
Order Number 74LCX240MTC or 74LCX240MTCX  
NS Package Number MTC20

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**National Semiconductor Corporation Americas**  
 Tel: 1(800) 272-9959  
 Fax: 1(800) 737-7018  
 Email: support@nsc.com  
<http://www.national.com>

**National Semiconductor Europe**  
 Fax: +49 (0) 180-530 85 86  
 Email: europe.support@nsc.com  
 Deutsch Tel: +49 (0) 180-530 85 85  
 English Tel: +49 (0) 180-532 78 32  
 Français Tel: +49 (0) 180-532 93 58  
 Italiano Tel: +49 (0) 180-534 16 80

**National Semiconductor Southeast Asia**  
 Fax: (852) 2376 3901  
 Email: sea.support@nsc.com

**National Semiconductor Japan Ltd.**  
 Tel: 81-3-5620-7561  
 Fax: 81-3-5620-6179

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